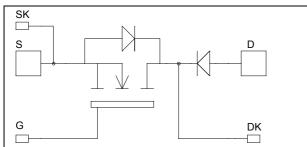


# Single switch with Series diodes **MOSFET Power Module**

 $V_{DSS} = 1200V$  $I_D = 171A$  @ Tc = 25°C



#### **Application**

Zero Current Switching resonant mode

#### **Features**

- Power MOS 7<sup>®</sup> MOSFETs
  - $Low \; R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration
- AlN substrate for improved thermal performance

#### **Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile
- **RoHS Compliant**

#### Absolute maximum ratings

Symbol	Parameter Parameter		Max ratings	Unit
$V_{ m DSS}$	Drain - Source Breakdown Voltage		1200	V
т	Continuous Drain Current	$T_c = 25$ °C	171	
$I_D$	Continuous Drain Current	$T_c = 80$ °C	126	A
$I_{DM}$	Pulsed Drain current	684		
$V_{GS}$	Gate - Source Voltage		±30	V
R <sub>DSon</sub>	Drain - Source ON Resistance		80	mΩ
$P_{D}$	Maximum Power Dissipation	$T_c = 25^{\circ}C$	5000	W
$I_{AR}$	Avalanche current (repetitive and non repetitive)		24	A
E <sub>AR</sub>	Repetitive Avalanche Energy		50	mJ
E <sub>AS</sub>	Single Pulse Avalanche Energy		3200	111,7

😘 🛤 UTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



## All ratings @ $T_j = 25^{\circ}C$ unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 1200V$ $T_j = 25^{\circ}C$			1.5	A	
		$V_{GS} = 0V, V_{DS} = 1000V$ $T_j = 125^{\circ}C$			6	mA	
R <sub>DS(on)</sub>	Drain – Source on Resistance	$V_{GS} = 10V, I_D = 85.5A$		70	80	mΩ	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 30 \text{mA}$	3		5	V	
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$			±600	nA	

**Dynamic Characteristics** 

•	Characteristic	Test Conditions	Min	Тур	Max	Unit	
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$		43.5			
$C_{oss}$	Output Capacitance	$V_{\rm DS} = 25V$		6.6		nF	
$C_{rss}$	Reverse Transfer Capacitance	f=1MHz		1.2			
$Q_{\mathrm{g}}$	Total gate Charge	$V_{GS} = 10V$		1650			
$Q_{\mathrm{gs}}$	Gate – Source Charge	$V_{Bus} = 600V$		192		nC	
$Q_{\mathrm{gd}}$	Gate – Drain Charge	$I_{D} = 171A$		1074			
$T_{d(on)}$	Turn-on Delay Time	Inductive switching @ 125°C		20			
$T_{\rm r}$	Rise Time	$\begin{split} V_{GS} &= 15V \\ V_{Bus} &= 800V \\ I_D &= 171A \\ R_G &= 0.8\Omega \end{split}$		17		ns	
$T_{d(off)}$	Turn-off Delay Time			245			
$T_{\mathrm{f}}$	Fall Time			62			
Eon	Turn-on Switching Energy	Inductive switching @ 25°C		7.6		m I	
$\mathrm{E}_{\mathrm{off}}$	Turn-off Switching Energy	$I_{D} = 15V, V_{Bus} = 800V$ $I_{D} = 171A, R_{G} = 0.8\Omega$		6.9		mJ	
Eon	Turn-on Switching Energy	Inductive switching @ 125°C		13.8			
E <sub>off</sub>	Turn-off Switching Energy	$I_{D} = 15V, V_{Bus} = 800V$ $I_{D} = 171A, R_{G} = 0.8\Omega$		8.5		mJ	

### Series diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$V_{RRM}$	Maximum Repetitive Reverse Voltage			1200			V
$I_{RM}$	Maximum Reverse Leakage Current	V <sub>R</sub> =1200V	$T_j = 25^{\circ}C$	750			μА
$I_{\mathrm{F}}$	DC Forward Current		$T_j = 125$ °C $T_c = 70$ °C		240	1000	A
1F	De Forward Current	T 240 A	1 <sub>c</sub> - 70 C			2.5	А
	Diode Forward Voltage	$I_F = 240A$		2	2.5	V	
$V_{\rm F}$		$I_F = 480A$		2.3			
		$I_F = 240A$	$T_j = 125$ °C		1.8		
$t_{rr}$	Reverse Recovery Time		$T_j = 25$ °C		400		ns
· <sub>rr</sub>		$I_F = 240A$ $V_R = 800V$	$T_{j} = 125^{\circ}C$		470		115
Q <sub>rr</sub>	Reverse Recovery Charge	$di/dt = 800A/\mu s$	$T_j = 25$ °C		4.8		μС
			$T_{j} = 125^{\circ}C$		16		μΟ

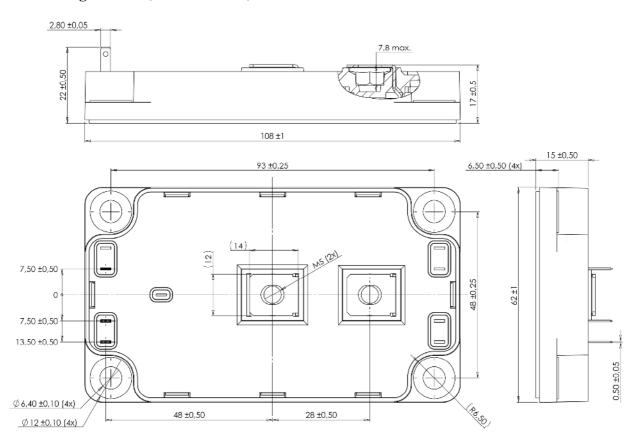
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### Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit	
D	Junction to Case Thermal Resistance		Transistor				0.025	°C/W
$R_{thJC}$			Series diode				0.23	C/W
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V	
$T_{J}$	Operating junction temperature range			-40		150	°C	
$T_{STG}$	Storage Temperature Range			-40		125		
$T_{\rm C}$	Operating Case Temperature			-40		100		
Torque	Mounting torque	To heatsir	ık	M6	3		5	N.m
Torque		For termin	nals	M5	2		3.5	11.111
Wt	Package Weight						300	g

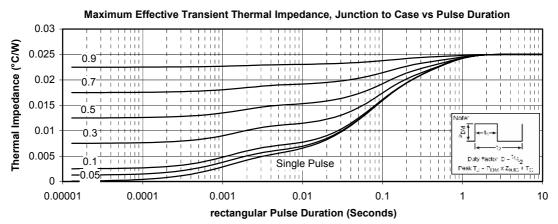
### SP6 Package outline (dimensions in mm)

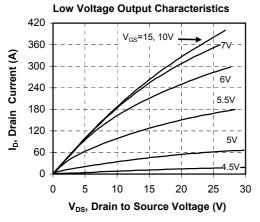


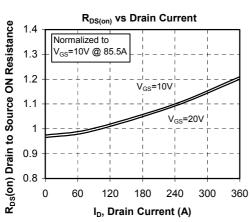
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

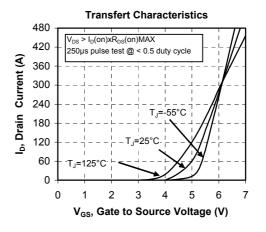


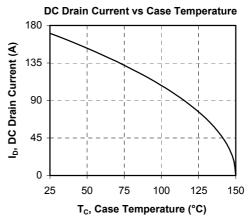
#### **Typical Performance Curve**



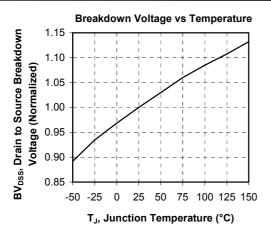


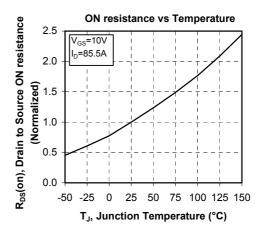


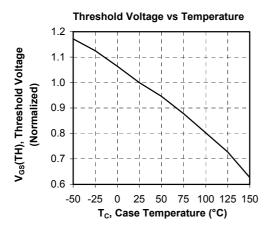


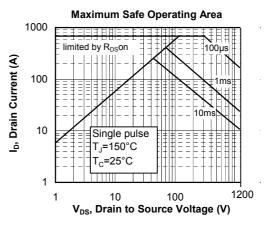


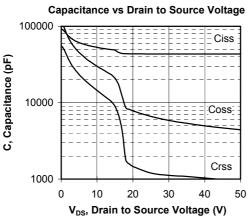


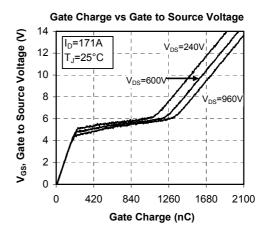




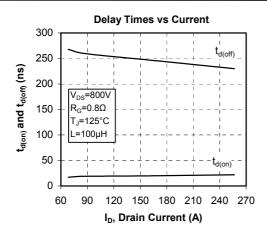


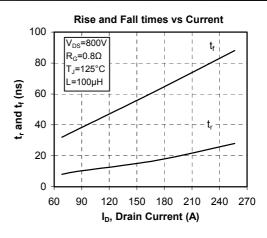


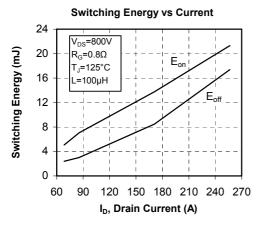


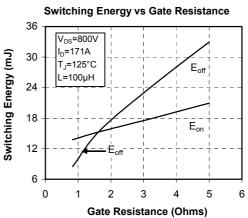


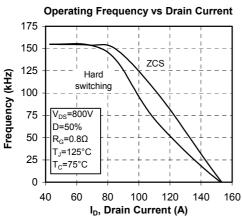


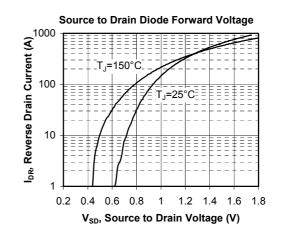












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